

ESD SMD Comm X7R, Ceramic, 0.1 uF, 20%, 50 VDC, X7R, SMD, MLCC, Temperature Stable, Electro Static Discharge, Class II, 0603



#### Dimensions

Chip Size	0603
L	1.6mm +/-0.15mm
W	0.8mm +/-0.15mm
T	0.8mm +/-0.07mm
S	0.7mm MIN
B	0.35mm +/-0.15mm

#### Packaging Specifications

Packaging:	T&R, 330mm, Paper Tape
Packaging Quantity:	15000

#### General Information

Series:	ESD SMD Comm X7R
Style:	SMD Chip
Description:	SMD, MLCC, Temperature Stable, Electro Static Discharge, Class II
Features:	Temperature Stable, Class II
RoHS:	Yes
Termination:	Tin
Marking:	No
AEC-Q200:	No
Miscellaneous:	Note: Referee time for X7R dielectric for this part number is 1000 hours.
Shelf Life:	78 Weeks
MSL:	1

#### Specifications

Capacitance:	0.1 uF
Measurement Condition:	1 kHz 1.0Vrms
Capacitance Tolerance:	20%
Voltage DC:	50 VDC
ESD Level per AEC-Q200:	25,000 V ESD Level
Dielectric Withstanding Voltage:	125 VDC
Temperature Range:	-55/+125°C
Temperature Coefficient:	X7R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC):	15%, 1kHz 1.0Vrms
Dissipation Factor:	2.5% 1kHz 1.0Vrms
Aging Rate:	3% Loss/Decade Hour
Insulation Resistance:	5 GOhms